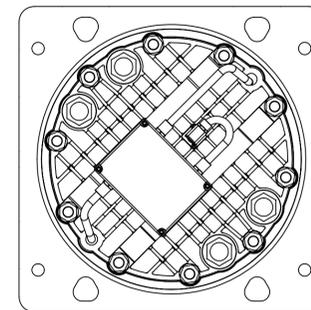
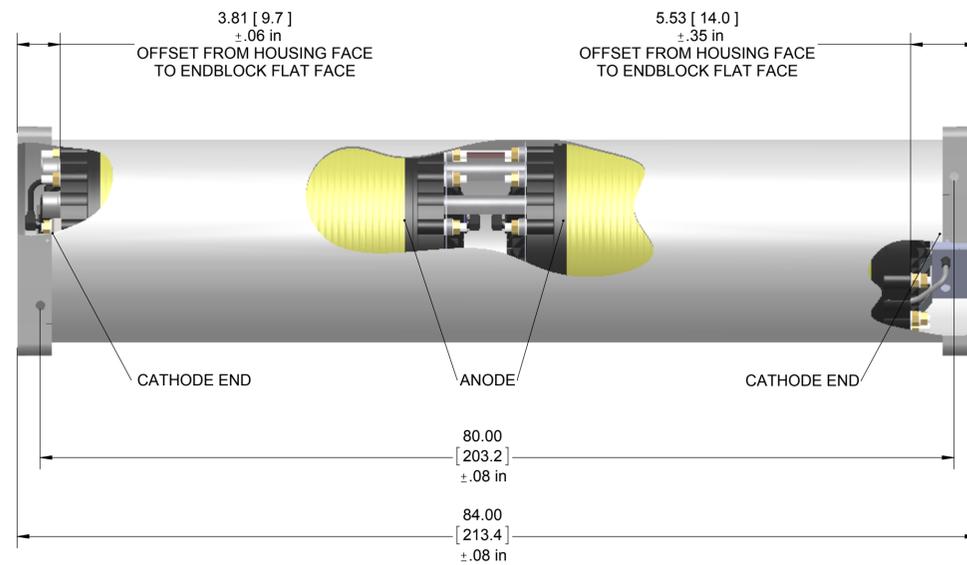
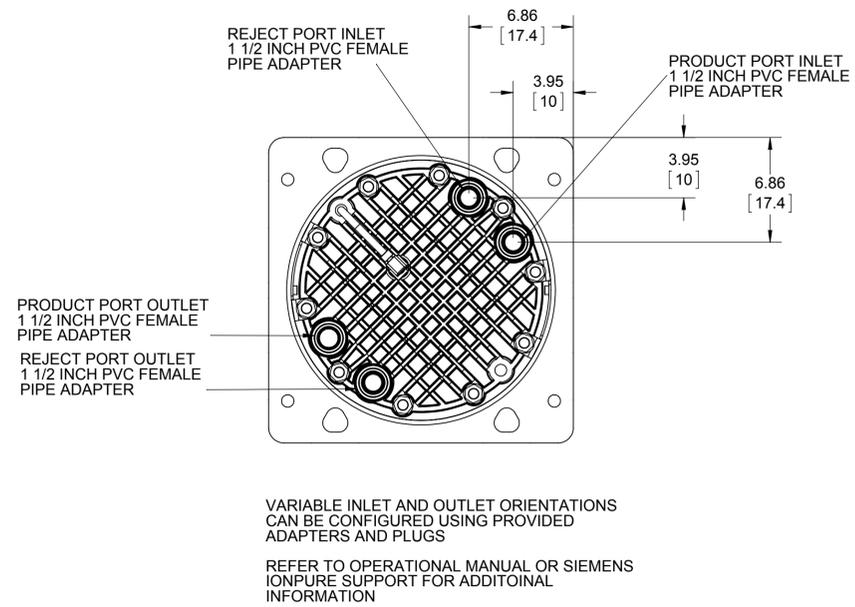
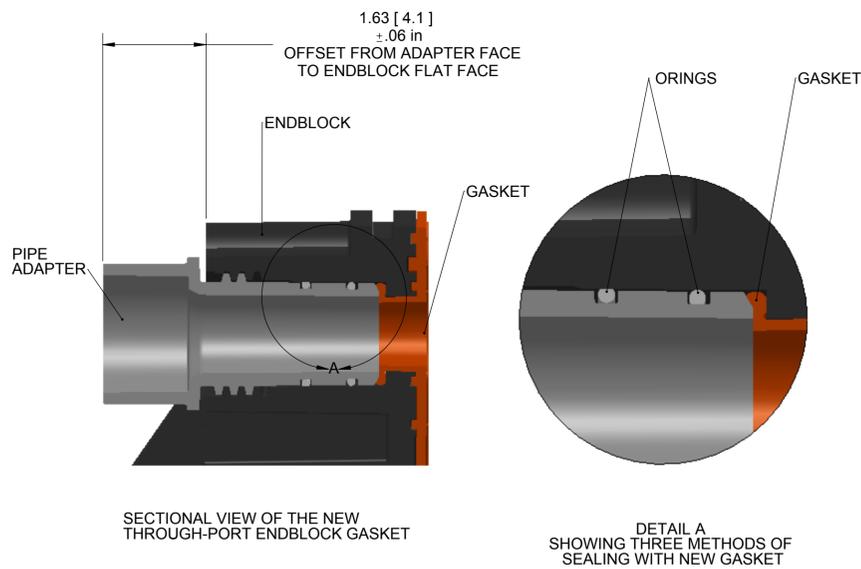


VNX 50-2 (OLDER MODEL)

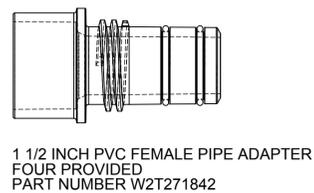
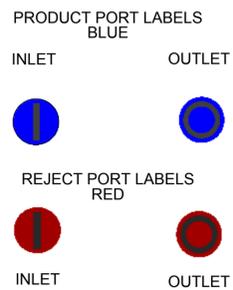
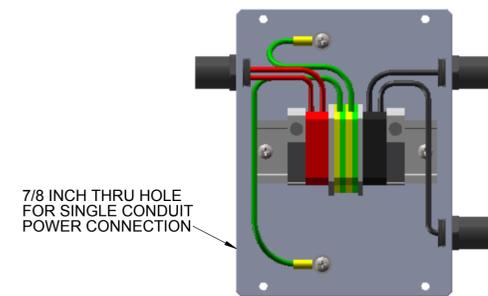
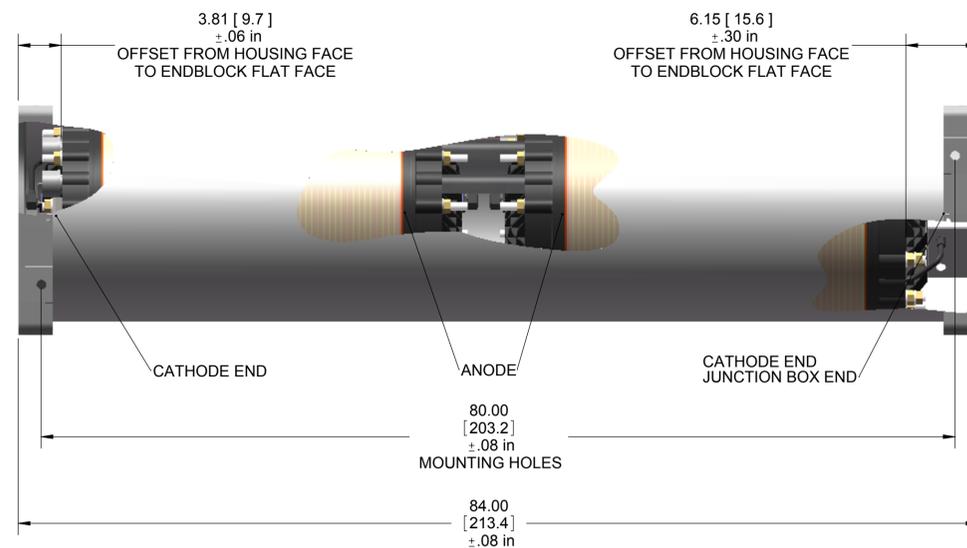


Siemens proudly announces the next advancement in Ionpure® CEDI technology. First launched in 2004, the VNX module has quickly become the standard in high flow systems for Power and Microelectronics. Through continued process and technical improvements the current module further improves performance and reduces installation requirements and cost.

- Use VNX 55-2 for improved performance or increased flow capability. To replace with equal flow/performance see VNX 50-3.
- The new VNX 55-2 increases flow capability by 10% to 55 GPM [12.5 m³/h].
- Updated internal sealing with through-port Endblock gaskets.
- Common electrical and process connection layout.
- All dimensions given in Inches, followed by Centimeters in brackets.



VNX 55-2 (2013 MODEL)



| | | | | | | | | | |
|--|---|---------|-----|------|------|-----|--|--|--|
| ALL DIMENSIONS ARE IN INCHES OR DEGREES UNLESS OTHERWISE SHOWN. ALL DISTANCE TOLERANCES UNLESS OTHERWISE SHOWN ARE: XX ±0.1, XXX ± 0.1, XXXX ± 0.05. ALL ANGLE TOLERANCES UNLESS OTHERWISE SHOWN ARE X ± 1°, XX ± 0.1°. | | | | | | | | | |
| B | UPDATED TOLERANCES AND GIVEN DIMENSIONS | 5/23/13 | HRF | JCT | CPB | | | | |
| A | INITIAL DESIGN | 1/23/13 | HRF | | | | | | |
| REV | DESCRIPTION | DATE | DWN | CHKD | APVD | ECN | | | |

COMPANY CONFIDENTIAL
THIS DOCUMENT AND ALL INFORMATION CONTAINED
HEREIN ARE THE PROPERTY OF SIEMENS AND/OR ITS
AFFILIATES. THE DESIGN CONCEPTS AND INFORMATION
CONTAINED HEREIN ARE PROPRIETARY TO SIEMENS
AND ARE SUBMITTED IN CONFIDENCE. THEY ARE
NOT TRANSFERABLE AND MUST BE USED ONLY FOR
THE PURPOSE FOR WHICH THE DOCUMENT IS
EXPRESSLY LOANED. THEY MUST NOT BE DISCLOSED,
REPRODUCED, LOANED OR USED IN ANY OTHER
MANNER WITHOUT THE EXPRESS WRITTEN CONSENT
OF SIEMENS. IN NO EVENT SHALL THEY BE USED IN ANY
MANNER DETRIMENTAL TO THE INTEREST OF SIEMENS.
ALL PATENT RIGHTS ARE RESERVED. UPON THE DEMAND
OF SIEMENS, THIS DOCUMENT, ALONG WITH ALL COPIES
AND EXTRACTS, AND ALL RELATED NOTES AND
ANALYSES, MUST BE RETURNED TO SIEMENS OR
DESTROYED AS INSTRUCTED BY SIEMENS. ACCEPTANCE
OF THE DELIVERY OF THIS DOCUMENT CONSTITUTES
AGREEMENT TO THESE TERMS AND CONDITIONS.

| | | |
|-----------------------|-------------------------|--------------------------------|
| DESIGNER H.FRYE | DATE 1/23/13 | TITLE VNX 50-2 VS. VNX 55-2 |
| CHECKER | DATE | |
| ENGINEER | DATE | |
| MANAGER | DATE | |
| FILE: 50-2 TO 55-2 RB | PROJECT RD3002 | FORMAT 22X34 D |
| SCALE: NA | DRAWING 50-2 TO 55-2 | SHEET 1 OF 1 |
| | | REV B |

